









Release Date: 24 June 2021 Version: A1.0

PRODUCT DATASHEET



- ► PTH Display
- ▶ 0.56" (14.2mm) 8.8.:8.8
- ► Red (630nm)

NOR59D56BS



PTH Display Series Compliant





SMD Display Series

APPLICATIONS:

- 7-Segment Display
- Digital Display
- Information Board
- Counter
- **Instrument Panels**
- Audio Equipment

- Package: PTH Numeral Quadruple Digits Display
- Forward Current: 20mA per diode
- Forward Voltage (typ.): 2.0V per diode
- **Luminous Intensity Matching Rate: 2.0:1**
- Colour: Red

FEATURES:

- Wavelength: 630nm
- Materials:
 - Die: AlGaInP
 - Resin: Epoxy (White Diffused)
 - Surface Colour: Black
- Operating Temperature: -25~+85°C
- Storage Temperature: -30~+85°C
- **Grouping parameters:**
 - Forward voltage
 - Luminous intensity
 - Dominant wavelength
- Soldering methods: Hand Solder or Reflow
- Preconditioning: acc. to JEDEC Level 3
- Packing: in carton



CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Forward Current *	IF	20	mA
Peak Forward Current Duty 1/10, 0.1ms width	I _{FP}	80	mA
Reverse Voltage	VR	5	V
Reverse Current @5V	I _R	100	μΑ
Power Dissipation	P _D	75	mW
Operating Temperature	T _{OPR}	-25~+85	°C
Storage Temperature	T _{STG}	-30~+85	°C

^{1.} All parameters are per diode.

Electrical & Optical Characteristics (Ta=25°C)

Parameter	Symbol	Values			l loi+	Test
		Min.	Тур.	Max.	Unit	Condition
Forward Voltage*	V_{F}	1.8	2.0	2.3	V	I _F =20mA
Luminous Intensity Matching Rate**	I _{V-m}			2.0:1		I _F =20mA
Luminous Intensity	lv		21.9		mcd	I _F =10mA
Dominant Wavelength	λ_{D}		630		nm	I _F =20mA
Spectral Line Half Bandwidth	Δλ		15		nm	I _F =20mA

^{1.} Luminous intensity (I_V) $\pm 15\%$, Forward Voltage (V_F) ± 0.1 V, Viewing angle($2\theta_{1/2}$) $\pm 5\%$

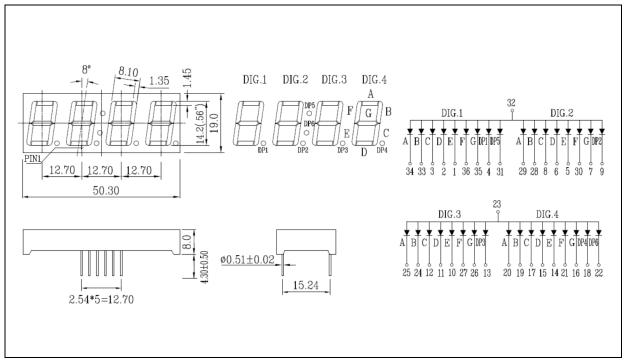
^{2. *} Voltage is per diode

^{3. **} Intensity is per segment



OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.2mm, unless otherwise noted.



PRECAUTIONS OF USE:

Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking before use.

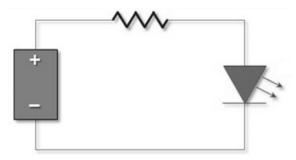
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±3°C x 24hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision
A1.0	24/06/2021	Datasheet set-up.